

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS}	-60	٧		
$R_{DS(on)} V_{GS} = 10 V$	62	mΩ		
$R_{DS(on)}$ $V_{GS} = 4.5 \text{ V}$	74	mΩ		
I _D	-40	Α		
Configuration	Single			

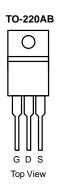
FEATURES

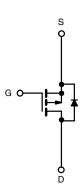
- TrenchFET® Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Gate-Source Voltage		V _{GS}	± 20	V		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	I-	-40			
	T _C = 100 °C	l _D	-30			
Pulsed Drain Current		I _{DM}	- 90	Α		
Continuing Source Current (Diode Conduction)		I _S	- 30	İ		
Avalanche Current		I _{AS}	- 28			
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ		
Maximum Power Dissipation	T _C = 25 °C	В	60 ^a	w		
	T _A = 25 °C	P _D	2 ^b] vv		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
hunding to Ambient	t ≤ 10 sec	R _{thJA}	20	25		
Junction-to-Ambient ^D	Steady State		62	75	°C/W	
Junction-to-Case		R _{thJC}	5	6		

Notes:

- a. See SOA curve for voltage derating.
- b. Surface Mounted on 1" x 1" FR-4 boad.

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Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static					· ·		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ	
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 175 °C			- 150	1	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			Α	
		V _{GS} = - 10 V, I _D = - 5 A		62			
Durin Course Co Chala Basistana h	r	V _{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		80			
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		110		$m\Omega$	
		V _{GS} = - 4.5 V, I _D = - 2 A		74			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic							
Input Capacitance	C _{iss}			1300		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		120			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge	Q_g			13			
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.3		nC	
Gate-Drain Charge	Q_{gd}			3.2			
Gate Resistance	R_g	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_{L} = 3.57 \Omega$		14	25	ne	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -8.4 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 2.5 \Omega$		15	25	ns	
Fall Time ^c	t _f]		7	12		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b					
Pulsed Current	I _{SM}			- 20		Α	
Forward Voltage ^b	V_{SD}	I _F = -2 A, V _{GS} = 0 V		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}	I _E = - 8 A, di/dt = 100 A/μs		50	80	ns	
Reverse Recovery Time	Q _{rr}	$_{\rm F}$ = - $_{\rm O}$ A, $_{\rm O}$ / $_{\rm O}$ = 100 A/ $_{\rm HS}$		80	120	nC	

Notes:

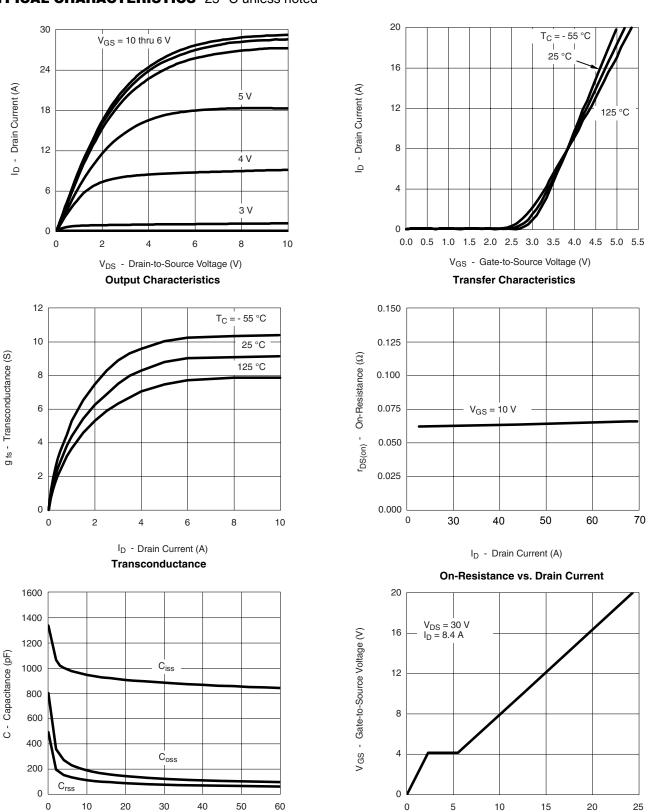
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS 25 °C unless noted



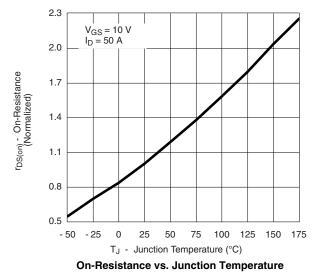
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 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$ Q_g - Total Gate Charge (nC)

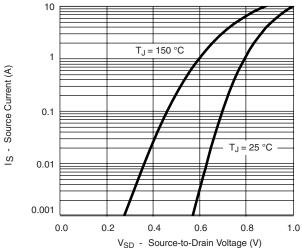
Gate Charge



TYPICAL CHARACTERISTICS 25 °C unless noted

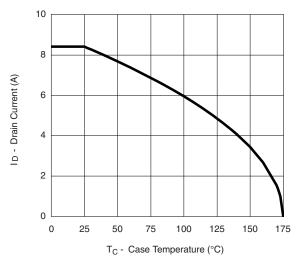




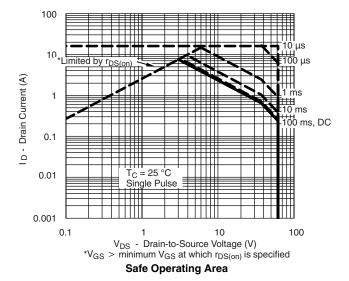


Source-Drain Diode Forward Voltage

THERMAL RATINGS



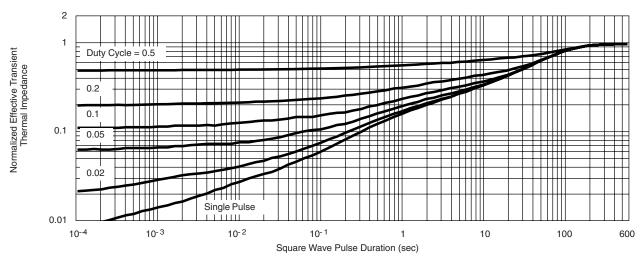
Drain Current vs. Case Temperature



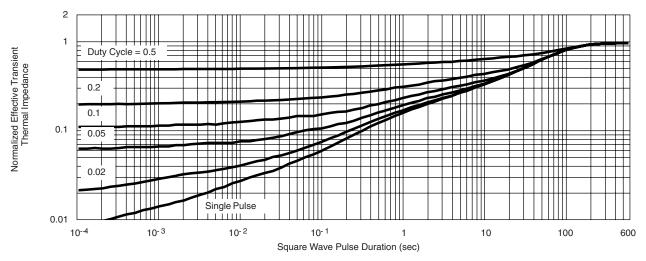
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THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Ambient



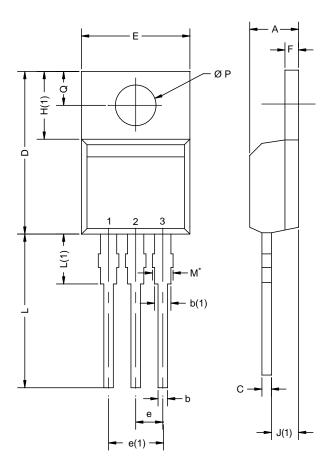
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220AB



	MILLIM	IETERS	HES			
DIM.	MIN.	MAX.	MIN.	MAX.		
А	4.25	4.65	0.167	0.183		
b	0.69	1.01	0.027	0.040		
b(1)	1.20	1.73	0.047	0.068		
С	0.36	0.61	0.014	0.024		
D	14.85	15.49	0.585	0.610		
Е	10.04	10.51	0.395	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.09	6.48	0.240	0.255		
J(1)	2.41	2.92	0.095	0.115		
L	13.35	14.02	0.526	0.552		
L(1)	3.32	3.82	0.131	0.150		
ØР	3.54	3.94	0.139	0.155		
Q	2.60	3.00	0.102	0.118		
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471						

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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